



# MEAS Silicon MEMS Piezoresistive Accelerometer and its Benefits

## 1. Bonded Strain Gage type

(Gages bonded to metal seismic mass using epoxy)

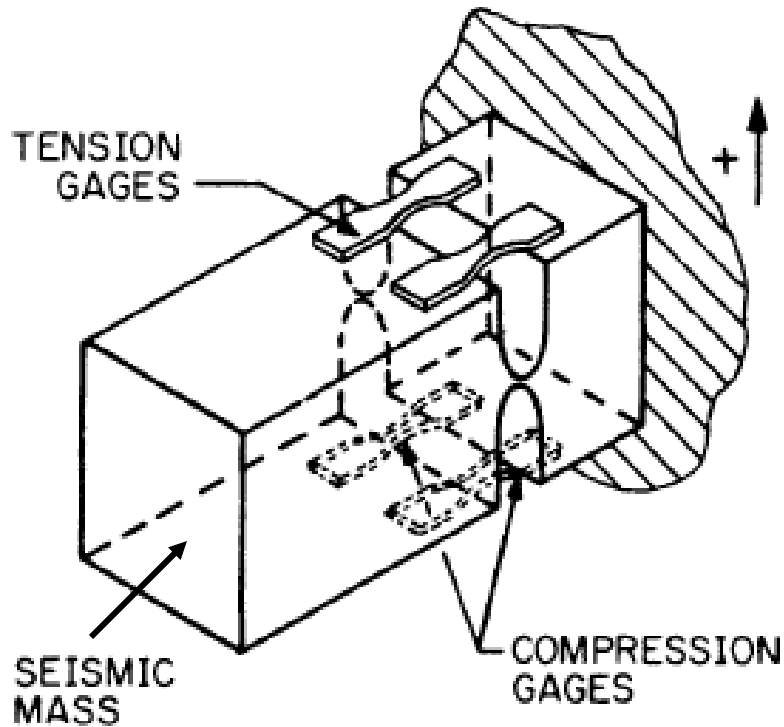
- Undamped                              circa 1950's
- Fluid (oil) damped                 circa 1960's

## 2. Silicon MEMS type

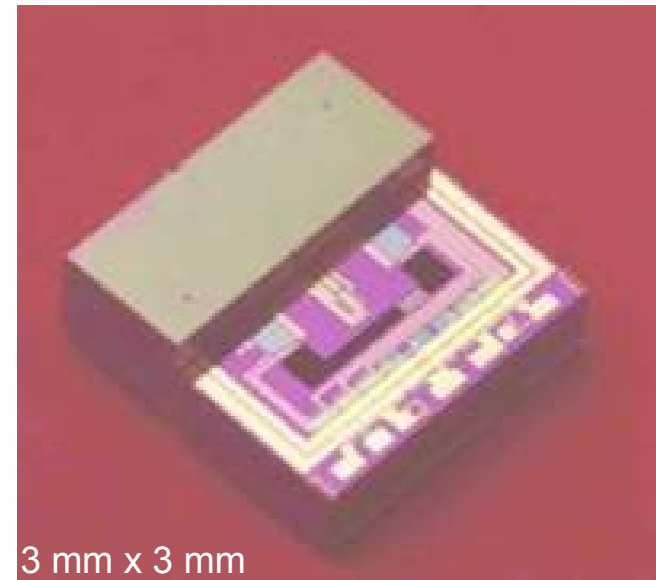
(Gages defused into single piece of silicon)

- Undamped                              circa 1980's
- Gas damped                            circa 1990's

# Piezoresistive Accelerometers



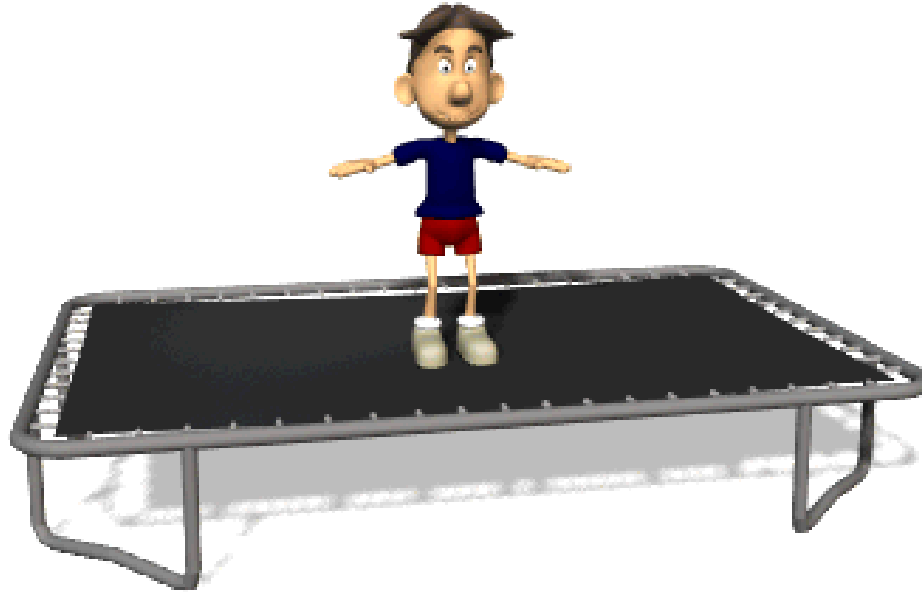
Typical Bonded Strain Gage  
Sub-Assembly



MEAS Silicon MEMS  
Element

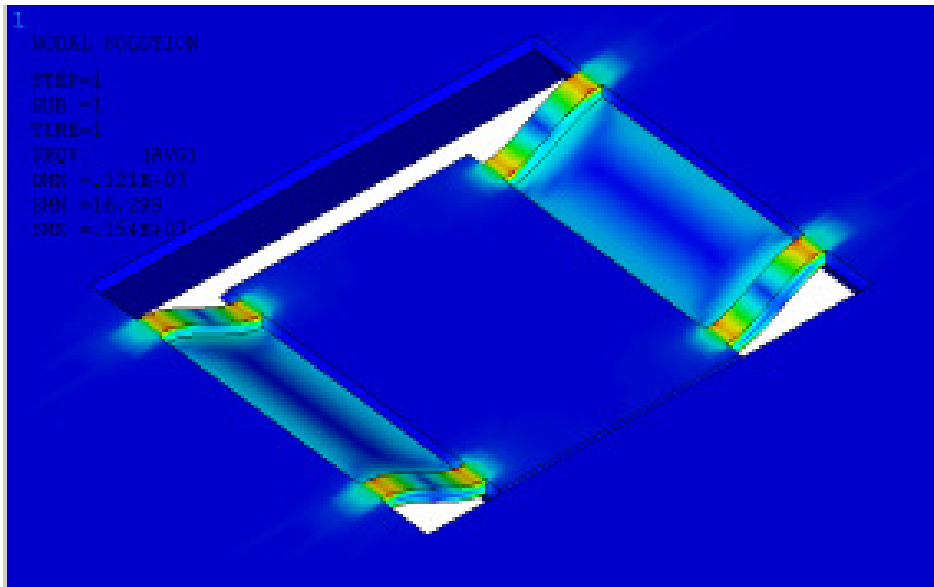
## How Silicon MEMS Accelerometers Work

**MEMS = Micro Electro Mechanical Systems**

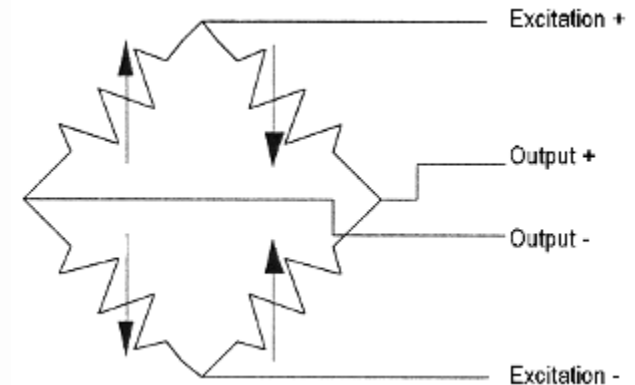


*Works Like a Trampoline*

## Silicon MEMS Construction:

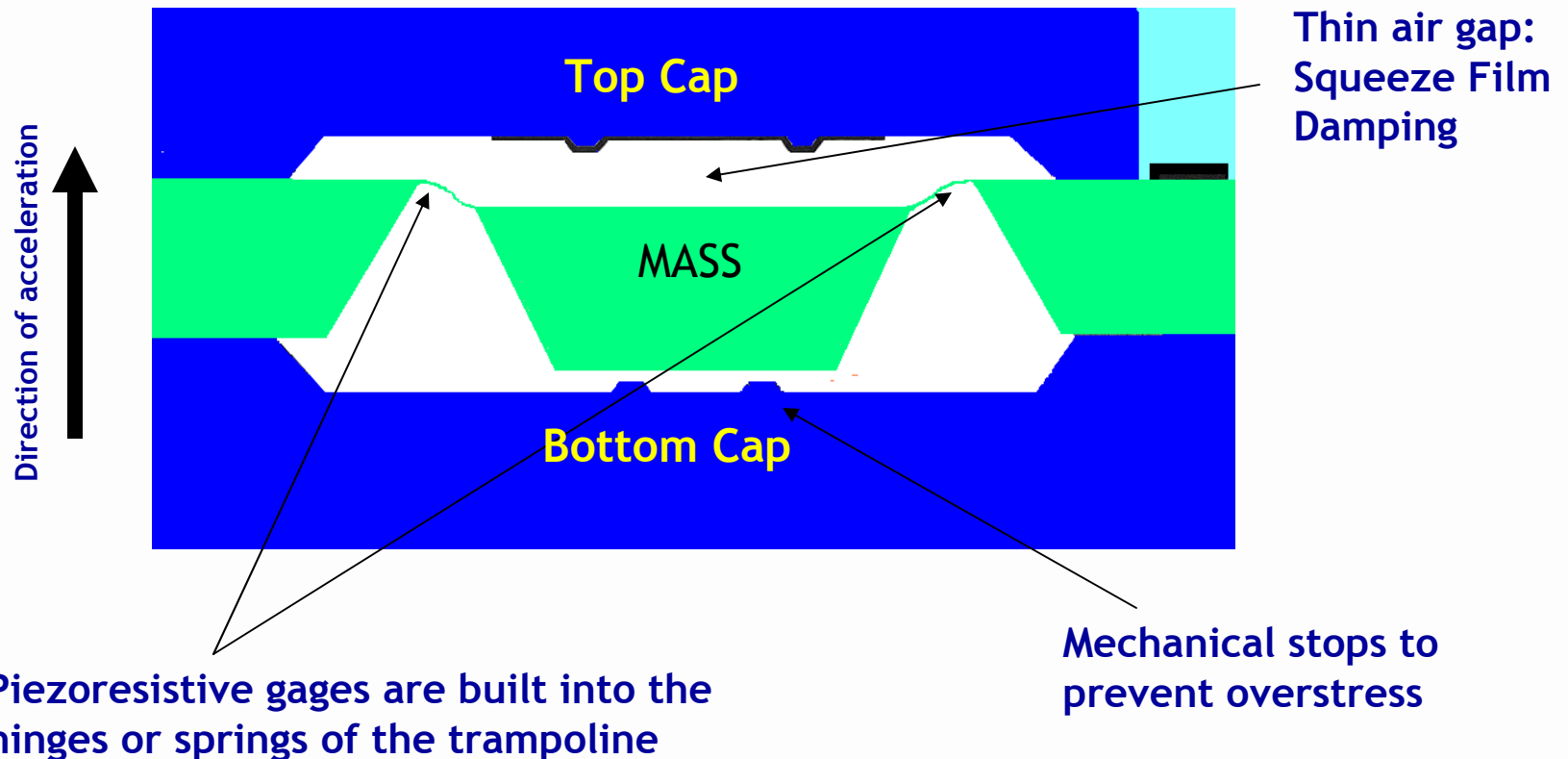


Piezoresistive gages sense changes in stress and strain in the hinges (springs in the trampoline) under acceleration



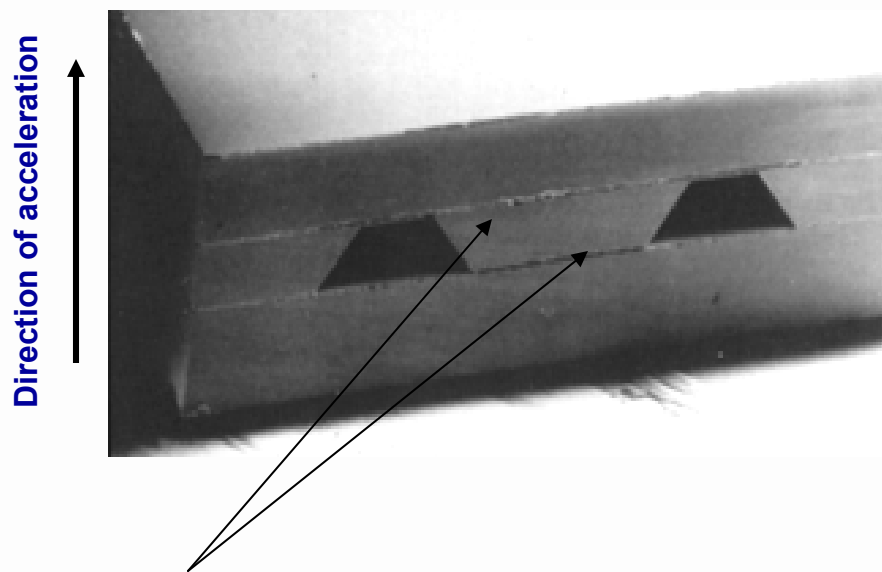
The four springs are wired in a 4-arm Wheatstone Bridge configuration

## Silicon MEMS Construction, Cross-sectional View



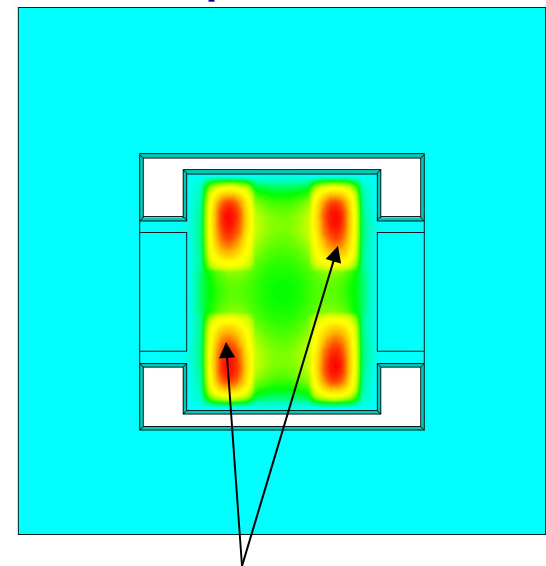
## Squeeze-Film Gas Damping

cross sectional view



Extremely small airgaps between the moving seismic mass (in the middle) and the top/bottom caps facilitate squeeze film damping.

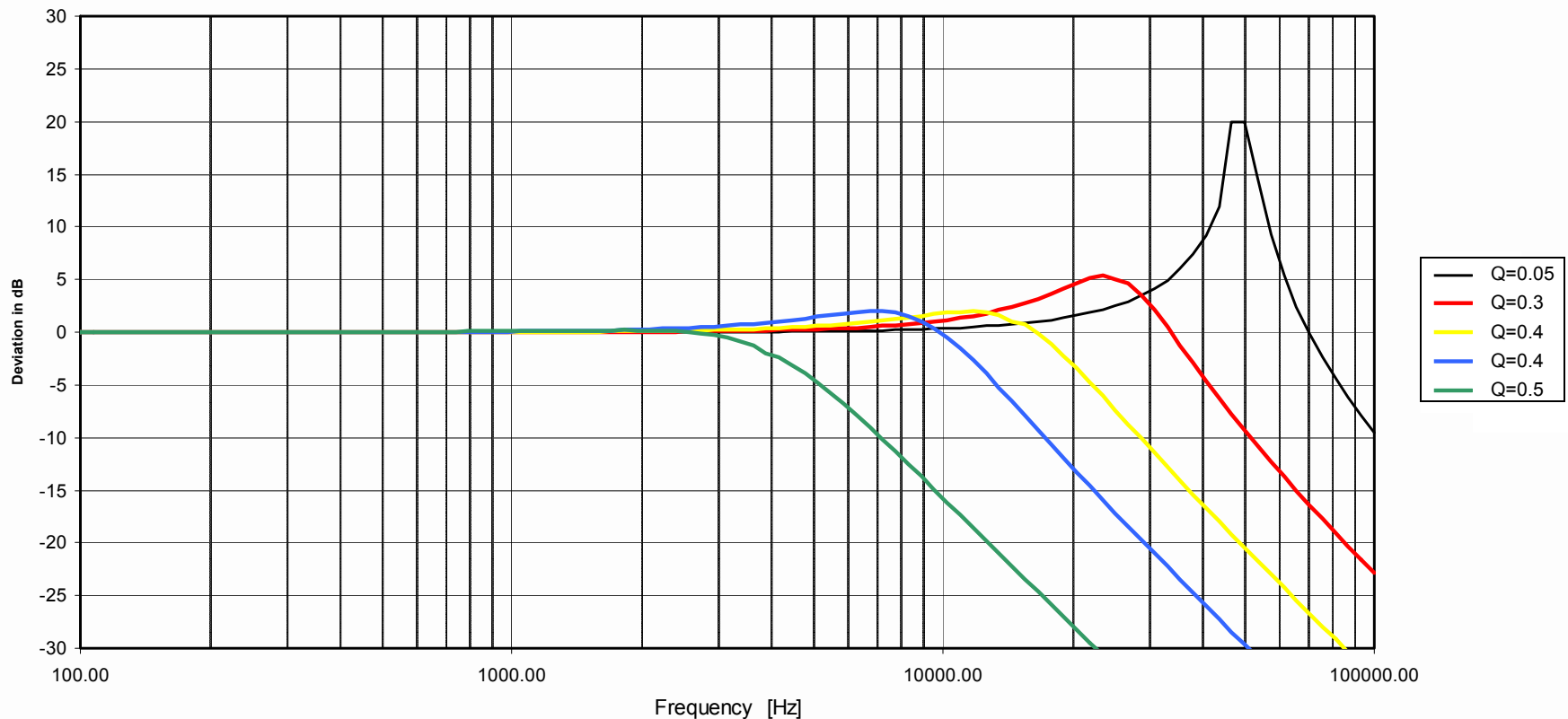
top view



Damping is obtained from the integrated pressure profile at the surface of the sensor cell. Airgap thickness controls the effective damping ratio of the device.



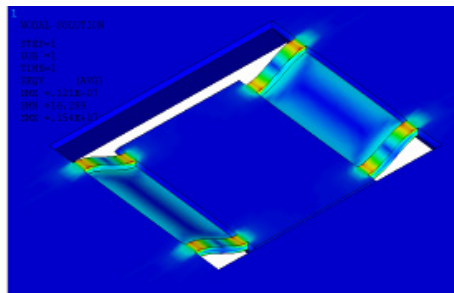
## Typical Damping Ratios Using Squeeze-Film Technique



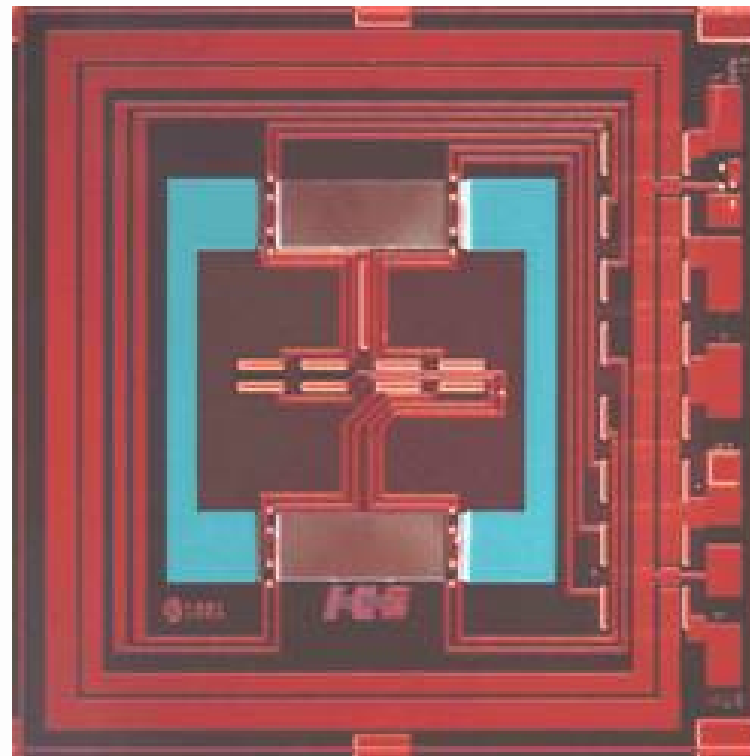
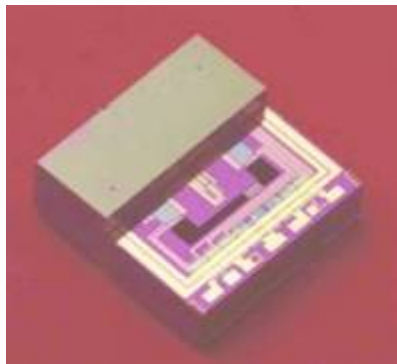
## What are the Benefits?

## Benefit: Low Off-Axis Sensitivity

Patented double-cantilever webbed design provides low off-axis sensitivity with minimum response to cross and rotation acceleration commonly found in dynamic testing.



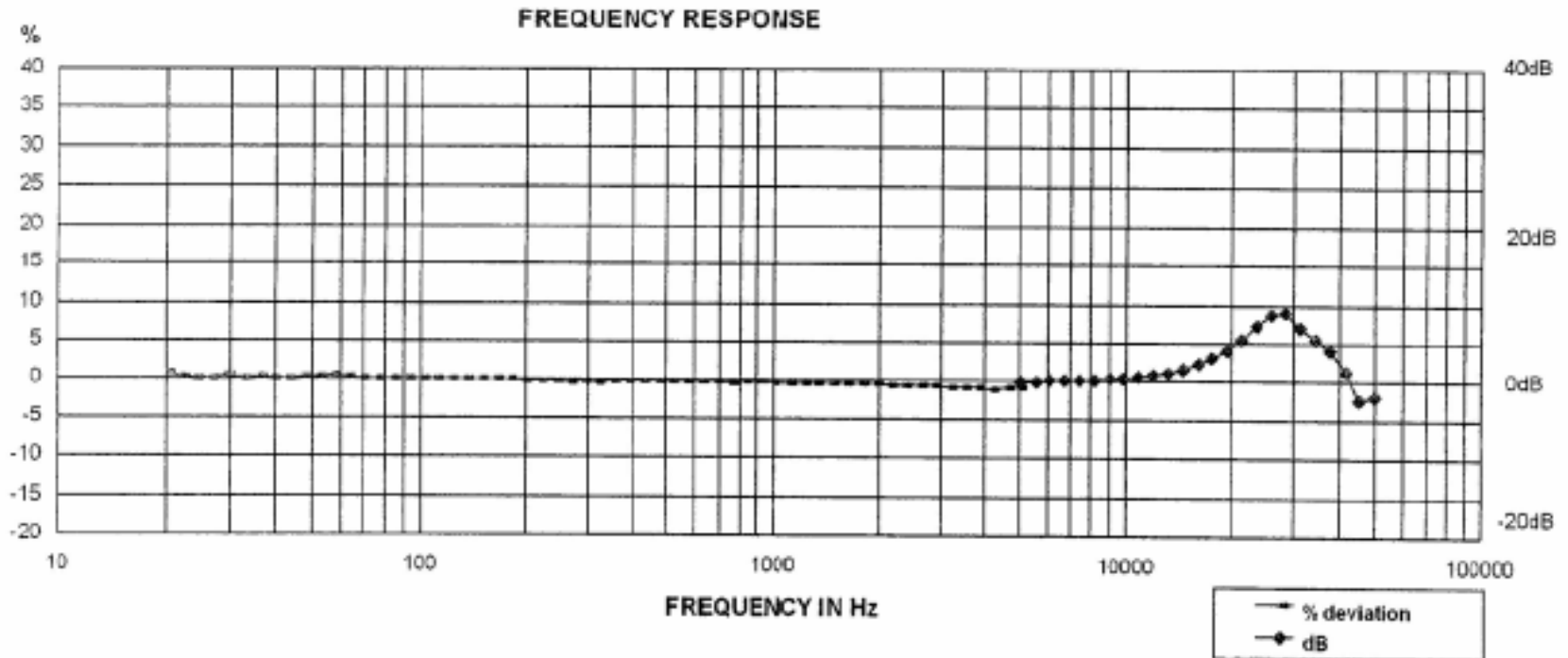
Silicon MEMS sensor element



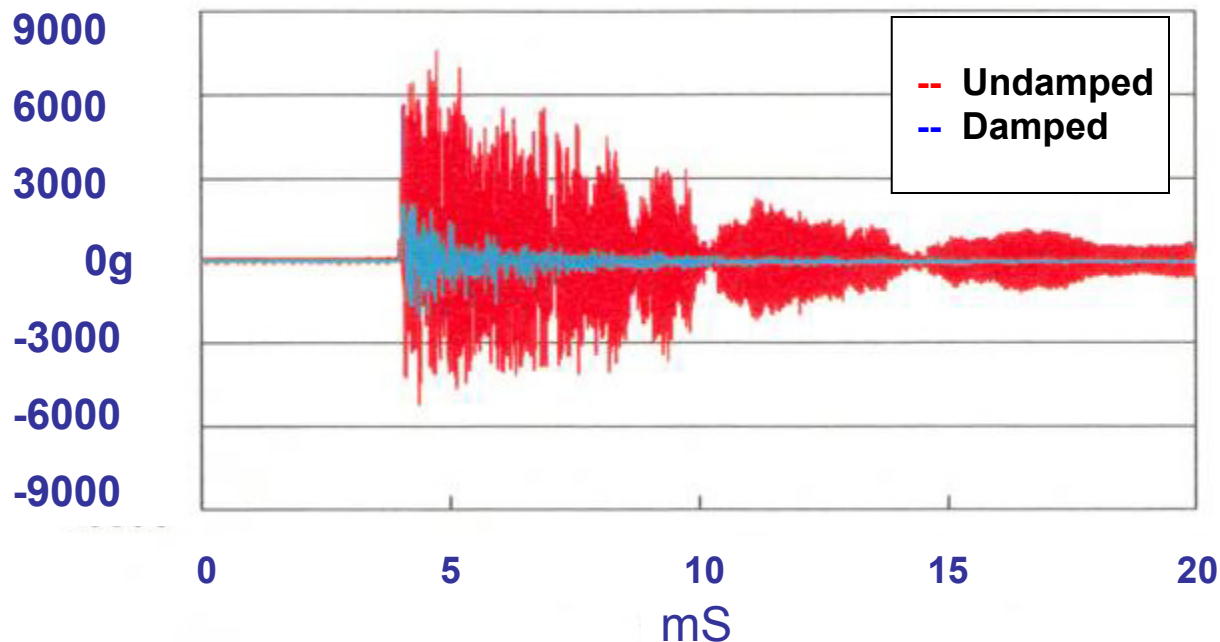
Sensor design with high rotational & translational stiffness

## Benefit: Resonance Control & Broad Response

MEAS's MEMS accelerometers offers the optimal amount of damping to achieve maximum resonance control when the sensor is exposed shock impact, and still maintains the broadest frequency response required by the various industry regulations, such as SAE-J211 and ISO-6487.



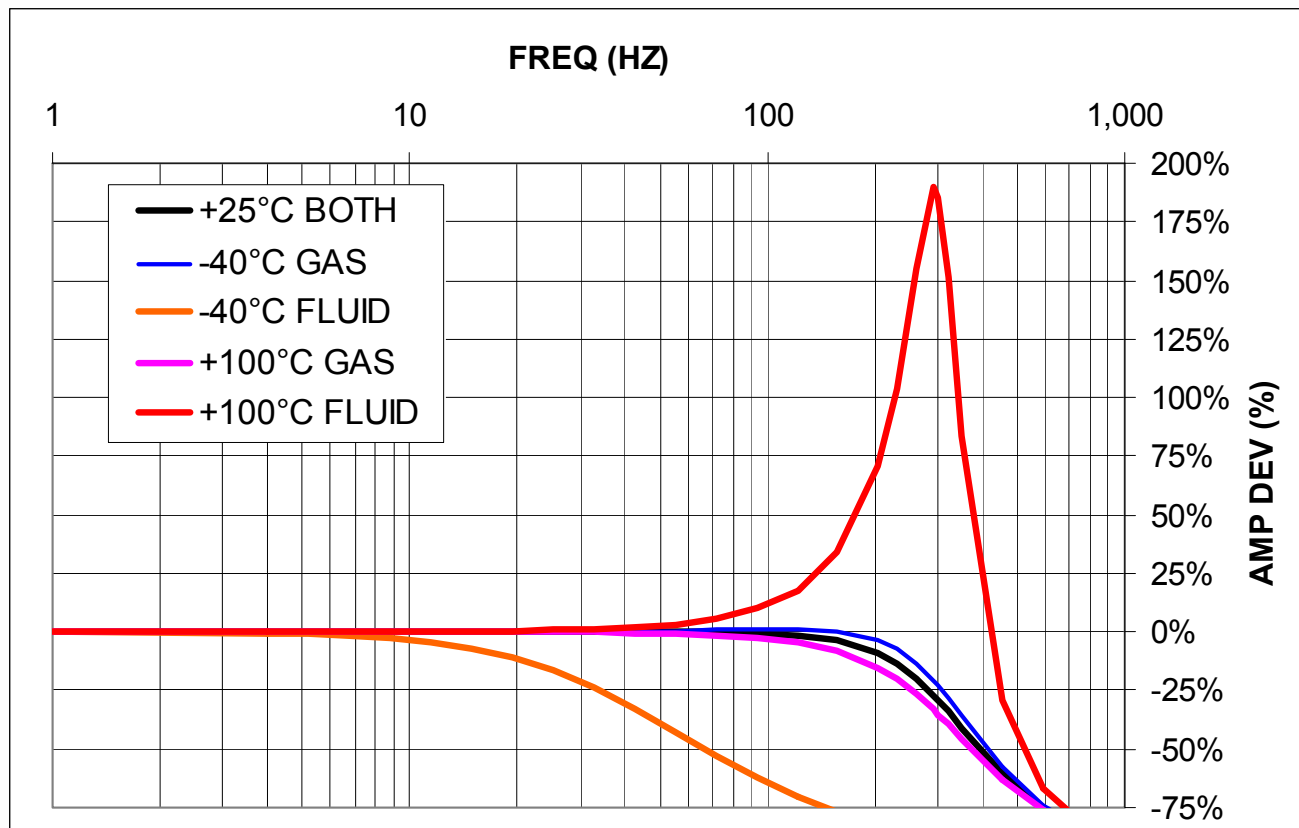
## Example of Resonance Control in Damped Accelerometer



Undamped accelerometer resonated at its natural frequency after exposed to shock impulses

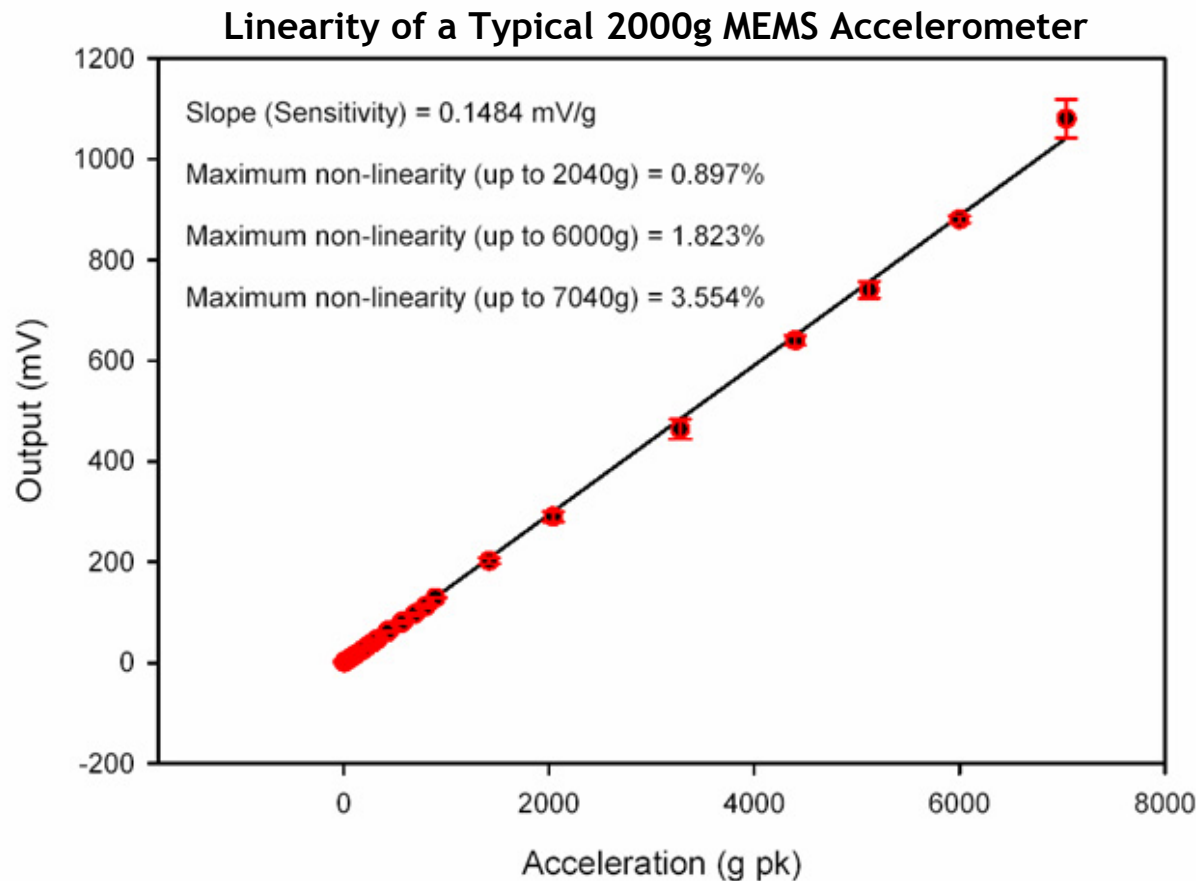
## Benefit: Stable Response over Temperature

Compared to a fluid damped design in which damping characteristics changes dramatically with fluid viscosity at various temperature, frequency response of MEAS's gas damped accelerometer is not affected by temperature.



## Benefit: Excellent Dynamic Range and Linearity

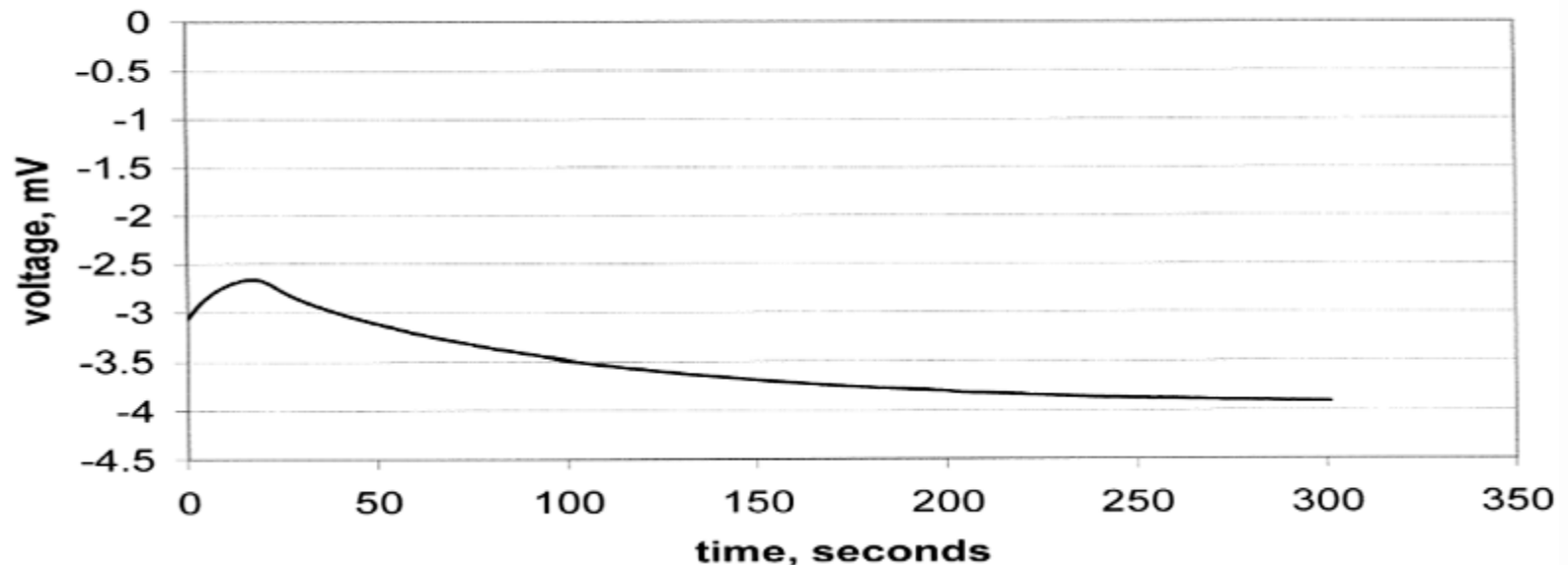
Compared to capacitive designs, MEAS's silicon MEMS piezoresistive accelerometers offer much broader measurement range and unmatched amplitude linearity.



## Benefit: Shorter Warm-Up Time

After power is applied to the sensor, the zero offset of the accelerometer stabilizes as the heat generated by the gages reaches an equilibrium. In a MEAS design, the thermal imbalance in the full bridge configuration is kept to a minimum due to the uniform heating in all 4 active silicon gages. Competitor's design using half-bridge configuration (2 active gages and 2 completion resistors) produces thermal imbalance due to uneven the heating characteristics that take much longer to reach an equilibrium.

**Zero signal**





## Benefit: Better Thermal Stability

With higher gage impedance, MEAS's design consumes considerably less power than competitor's sensor, hence lower heat dissipation. Lower heat dissipation translates into higher thermal stability and faster warm-up time.

